ASSOCIATION CONNECTING ELECTRONICE INDUSTRIES® International and Par	PC, Bannockt	ourn, Illinois. A	Ill rights reserved untions.	under both	This docume level parts, t	ent is a declara the declaration	ion of the s encompasse	ubstances es all lowe	within the man r level materials	ufacturer lis s for which	sted item. Note: if the manufacturer	the item is an a has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				*	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					ls and Mfg Information			
upplier Information														
Company name* Con			Company unique ID			Unique ID Authority				Re	Response Date*			
onsemi										202	2025-06-04			
ntact Name Title - Contact				Phone - Contact*				En	Email - Contact*					
Product-Env-Stewards Product Enviro C			o Compliance		NA			Pr	Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			sentative	ative P		Phone - Representative*			En	Email - Representative*				
Product-Env-Stewards Product Envir			nviro Compliance			NA				Pr	Product-Env-Stewards@onsemi.com			
Requester Item Number	Requester Item Number Mfr Item N		Number Mfr Item Name			Effective Dat	e Version]	Manufacturing Site		Weight*	UOM	Unit Type	
	FAN486	FAN48632UC35X 3MHZ DC/DC		Boost 1.5A		2025-06-04		-	TW6		3.376766	mg	Each	
Ianufacturing Proccess Informa	tion													
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base Alloy			J-STD-020 MS	FD-020 MSL Rating Peak Process Body Temperature Max Ti					t Peak Tem	perature Numb	er of Reflow Cy	cles	
SnAgCu CU Alloy				1		260		С	30	5	seconds 3			
omments														
vel 1 - maximum time at peak temperatu	ire during sol	Idering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).										
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure		
Backside Protection Film	0.10182	mg		Epoxy resin	proprietary data		0.0213	mg		
			Supplier	Carbon Black (C)	1333-86-4		0.0019	mg		
			Supplier	Acrylic resins	Proprietary Data		0.0213	mg		
			Supplier	Silica (SiO2)	14464-46-1		0.0573	mg		
Die	2.26993	mg	Supplier	Silicon (Si)	7440-21-3		2.2699	mg		
Solder Ball	0.973411	mg	Supplier	Silver (Ag)	7440-22-4		0.0389	mg		
			Supplier	Tin (Sn)	7440-31-5		0.9296	mg		
			Supplier	Copper (Cu)	7440-50-8		0.0049	mg		
Under Bump Metal	0.031605	mg	Supplier	Titanium (Ti)	7440-32-6		0.0079	mg		
			Supplier	Copper (Cu)	7440-50-8		0.0237	mg		